



Is Now Part of



**ON Semiconductor®**

To learn more about ON Semiconductor, please visit our website at  
[www.onsemi.com](http://www.onsemi.com)

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at [www.onsemi.com](http://www.onsemi.com). Please email any questions regarding the system integration to [Fairchild\\_questions@onsemi.com](mailto:Fairchild_questions@onsemi.com).

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.



## FSUSB22 — Low-Power, 2-Port, High-Speed USB 2.0 (480Mbps) Switch

### Features

- -40dB Off Isolation at 250MHz
- -40dB Non-adjacent Channel Crosstalk at 250MHz
- On Resistance: 4.5Ω Typical (R<sub>ON</sub>)
- -3dB Bandwidth: 750MHz
- Low-Power Consumption: 1μA Maximum
- Control Input: TTL Compatible
- Bi-directional Operation
- USB High-Speed and Full-Speed Signaling Capability

### Description


FSUSB22 is a low-power, high-bandwidth switch specially designed for applications switching high-speed USB 2.0 signals in handset and consumer applications; such as cell phone, digital camera, and notebook with hubs or controllers of limited USB I/O. The wide bandwidth (750MHz) allows signals to pass with minimum edge and phase distortion. Superior channel-to-channel crosstalk results in minimal interference. It is compatible with the USB2.0 Hi-Speed standard.

### Applications

- Cell Phones, PDAs, Digital Cameras, Notebook Computers

### Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FSUSB22BQX	-40 to +85°C	16-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.5mm	Tape and Reel
FSUSB22QSC	-40 to +85°C	16-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150-inch Wide	Tube
FSUSB22QSCX	-40 to +85°C	16-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150-inch Wide	Tape and Reel
FSUSB22MTC	-40 to +85°C	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide	Tube
FSUSB22MTCX	-40 to +85°C	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide	Tape and Reel

 All packages are lead free per JEDEC: J-STD-020B standard.

### Logic Diagram

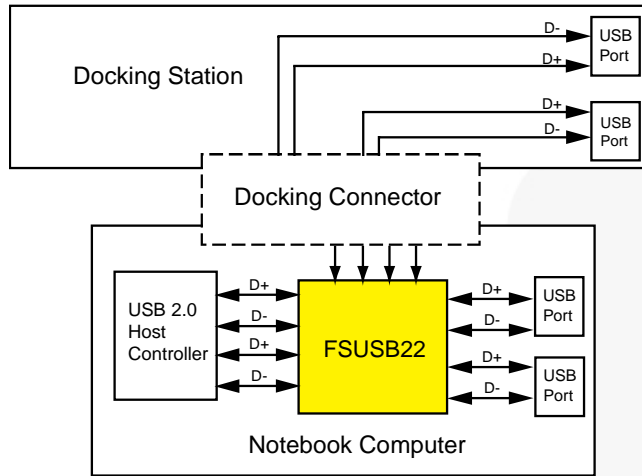


Figure 1. Logic Diagram

### Analog Symbol

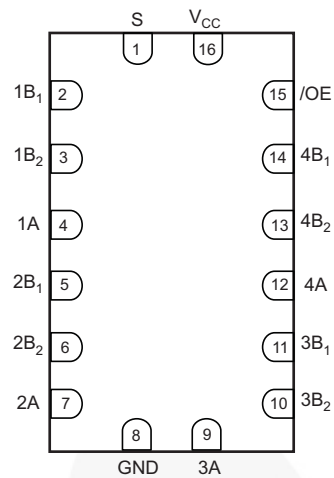


Figure 2. Analog Symbol

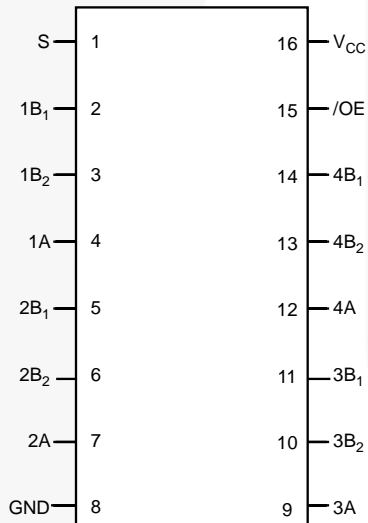


Figure 3. QSOP and TSSOP Pin Configuration

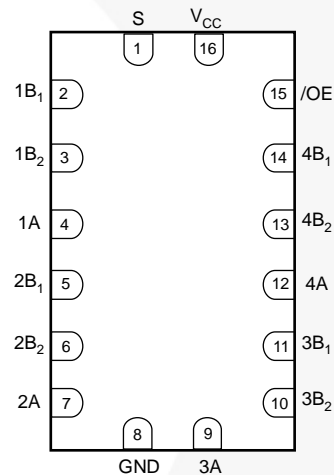


Figure 4. Pad Assignment for DQFN

### Pin Descriptions

Pin #	Pin Names	Description
1	S	Select Input
2,3,5,6,10,11,13,14	1B <sub>1</sub> ,1B <sub>2</sub> , 2B <sub>1</sub> ,2B <sub>2</sub> ,3B <sub>2</sub> ,3B <sub>1</sub> ,4B <sub>2</sub> ,4B <sub>1</sub>	Bus B
8	GND	Ground
4,7,9,12	1A,2A,3A,4A	Bus A
15	/OE	Bus Switch Enable
16	V <sub>CC</sub>	Supply Voltage

### Truth Table

S	OE	Function
Don't Care	HIGH	Disconnect
LOW	LOW	A=B <sub>1</sub>
HIGH	LOW	A=B <sub>2</sub>

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
$V_{CC}$	Supply Voltage	-0.5	4.6	V
$V_S$	DC Switch Voltage	-0.5	$V_{CC} + 0.05$	V
$V_{IN}$	DC Input Voltage <sup>(1)</sup>	-0.5	4.6	V
$I_{IK}$	DC Input Diode Current, $V_{IN} < 0V$		-50	mA
$I_{OUT}$	DC Output Sink Current		128	mA
$I_{CC} / I_{GND}$	DC $V_{CC}$ / GND Current		$\pm 100$	mA
$T_{STG}$	Storage Temperature Range	-65	+150	°C
ESD	Human Body Model, JESD22-A114		4	kV

### Note:

- The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Min.	Max.	Unit
$V_{CC}$	Power Supply Operating		3.0	3.6	V
$V_{IN}$	Input Voltage		0	$V_{CC}$	V
$V_{OUT}$	Output Voltage		0	$V_{CC}$	V
$t_r, t_f$	Input Rise and Fall Time	Switch Control Input <sup>(2)</sup>	0	5	ns/V
		Switch I/O	0	DC	
$T_A$	Operating Temperature, Free Air		-40	+85	°C

### Note:

- Unused control inputs must be held HIGH or LOW. They may not float.

## DC Electrical Characteristics

Typical values are at  $V_{CC} = 3.0V$  and  $T_A = 25^\circ C$ .

Symbol	Parameter	Conditions	$V_{CC}$ (V)	$T_A = -40$ to $+85^\circ C$			Units
				Min.	Typ.	Max.	
$V_{IK}$	Clamp Diode Voltage	$I_{IN} = -18mA$	3.0			-1.2	V
$V_{IH}$	High-Level Input Voltage		3.0 to 3.6	2.0			V
$V_{IL}$	Low-Level Input Voltage		3.0 to 3.6			0.8	V
$I_{IN}$	Input Leakage Current	$0 \leq V_{IN} \leq 3.6V$	3.6			$\pm 1.0$	$\mu A$
$I_{OFF}$	Off-state Leakage Current	$0 \leq A, B \leq V_{CC}$	3.6			$\pm 1.0$	$\mu A$
$R_{ON}$	Switch On Resistance <sup>(3)</sup>	$V_{IN} = 0.8V, I_{ON} = 8mA$	3.0		5	7	$\Omega$
		$V_{IN} = 3.0V, I_{ON} = 8mA$	3.0		4.5	6.5	
$\Delta R_{ON}$	Delta $R_{ON}$	$V_{IN} = 0.8V, V_{IN} = 0V - 1.5, I_{ON} = 8mA$	3.0		0.3		$\Omega$
$R_{FLAT(ON)}$	On Resistance Flatness <sup>(4)</sup>	$I_{OUT} = 8mA$	3.0		1		$\Omega$
$I_{CC}$	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	3.6			1	$\mu A$

### Notes:

- Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the A or B pins.
- Flatness is defines as the difference between the maximum and the minimum value on resistance over the specified range of conditions.

## AC Electrical Characteristics

Typical values are at  $V_{CC} = 3.0V$  and  $T_A = 25^\circ C$ .

Symbol	Parameter	Conditions	$V_{CC}(V)$	Min.	Typ.	Max.	Units	Figure
$t_{ON}$	Turn-on Time S-to-Bus B		3.0 to 3.6		4.5	6.0	ns	Figure 9 Figure 10
$t_{OFF}$	Turn-off Time S-to-Bus B		3.0 to 3.6		2.5	4.0	ns	Figure 9 Figure 10
$t_{PD}$	Propagation Delay	$C_L = 10pF$	3.0 to 3.6		0.25		ns	Figure 14
$O_{IRR}$	Non-Adjacent Off Isolation	$f = 250MHz,$ $R_L = 50\Omega$	3.0 to 3.6		-30		dB	Figure 11
$X_{TALK}$	Non-Adjacent Channel Crosstalk	$f = 250MHz,$ $R_L = 50\Omega$	3.0 to 3.6		-38		dB	Figure 12
BW	-3dB Bandwidth	$R_L = 50\Omega$	3.0 to 3.6		750		MHz	Figure 13

## USB Related AC Electrical Characteristics

Typical values are at  $V_{CC} = 3.0V$  and  $T_A = 25^\circ C$ .

Symbol	Parameter	Conditions	$V_{CC} (V)$	Min.	Typ.	Max.	Units	Figure
$t_{SK(O)}$	Channel-to Channels Skew	$C_L = 10pF$	3.0 to 3.6		0.051		pF	Figure 14 Figure 16
$t_{SK(P)}$	Skew of Opposite Transition of the Same Output	$C_L = 10pF$	3.0 to 3.6		0.020		pF	Figure 14 Figure 16
$T_J$	Total Jitter	$R_L = 50\Omega,$ $C_L = 10pF$ $t_R = t_F = 750ps$ at 480MPs	3.0 to 3.6		0.210			

## Capacitance

Typical values are at  $V_{CC} = 3.0V$  and  $T_A = 25^\circ C$ .

Symbol	Parameter	Conditions	Typ.	Units
$C_{IN}$	Control Pin Input Capacitance	$V_{CC} = 0V$	2.5	pF
$C_{ON}$	A/B On Capacitance	$V_{CC} = 3.3V, /OE = 0V$	12	pF
$C_{OFF}$	Port B Off Capacitance	$V_{CC}$ and $/OE = 3.3V$	4.5	pF

## Performance Characteristics

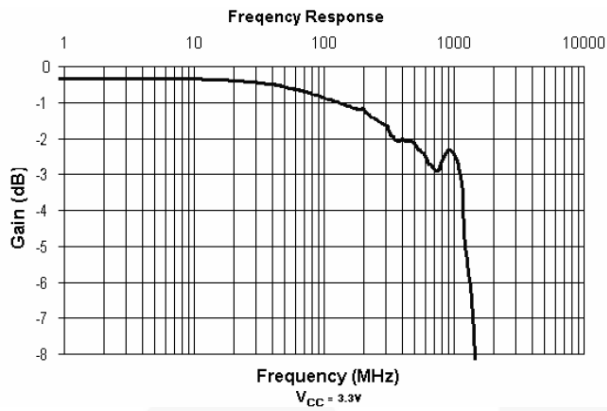


Figure 5. Gain vs. Frequency

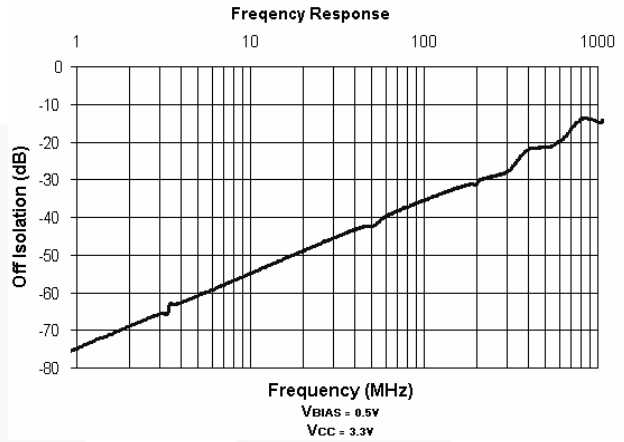


Figure 6. Off Isolation

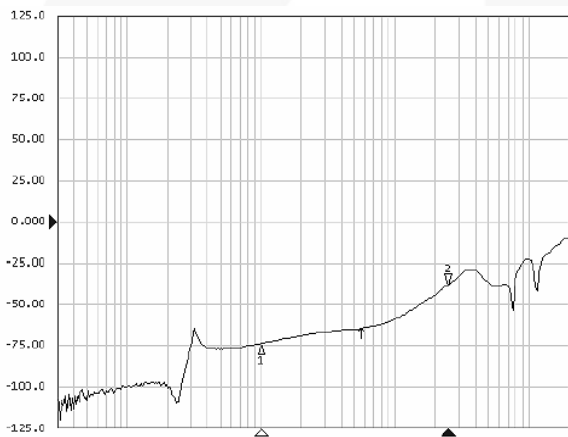


Figure 7. Crosstalk

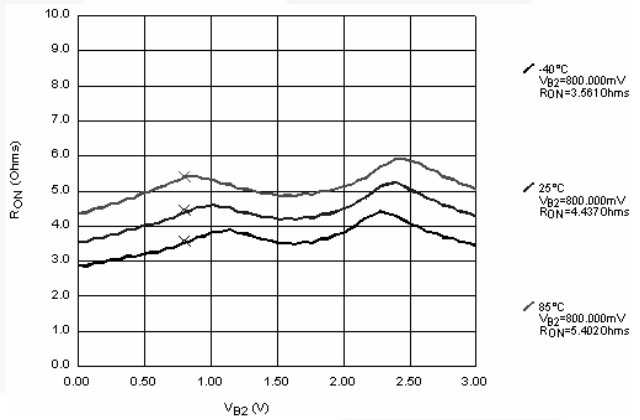
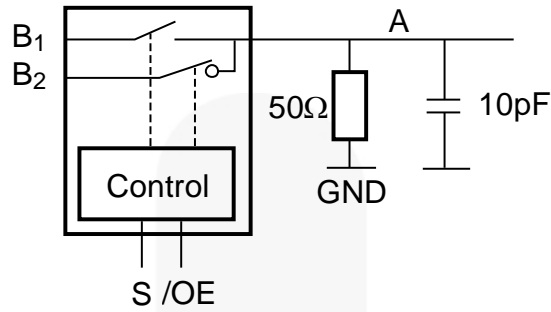


Figure 8. RON

## AC Loadings and Waveforms



Notes: Input driven by 50Ω source terminated in 50Ω.  
 CL includes load and stray capacitance.  
 Input PRR-1.0MHz,  $t_w = 500\text{ns}$ .

Figure 9. AC Test Circuit

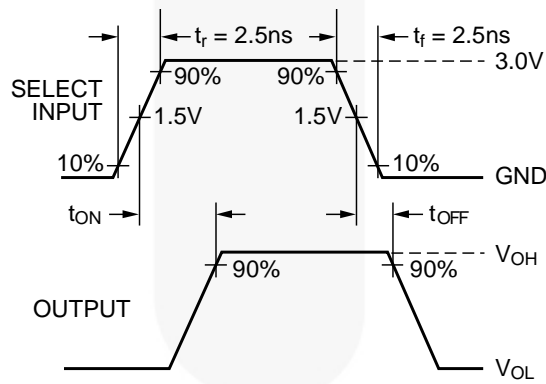


Figure 10. AC Waveforms

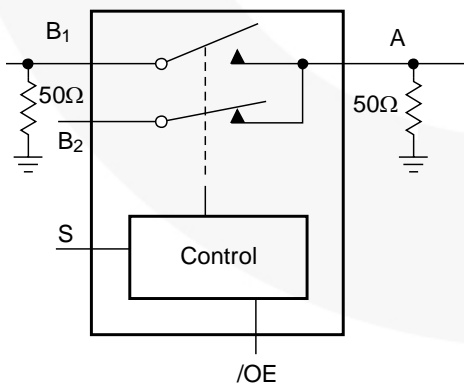


Figure 11. Off Isolation Test

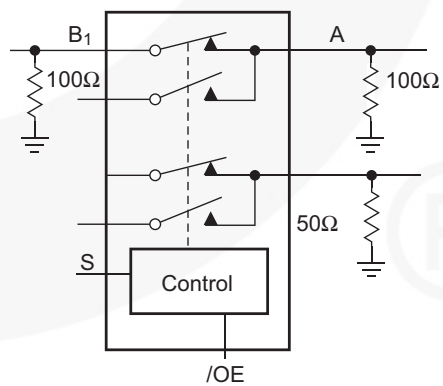


Figure 12. Crosstalk Test



AC Loadings and Waveforms

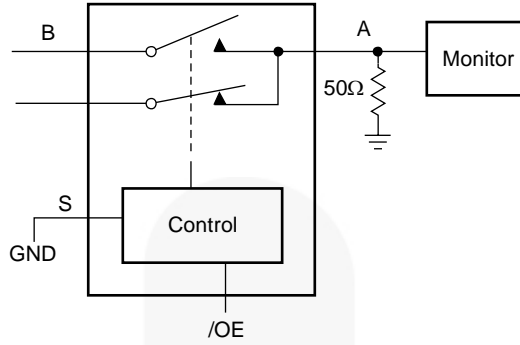


Figure 13. Bandwidth Test

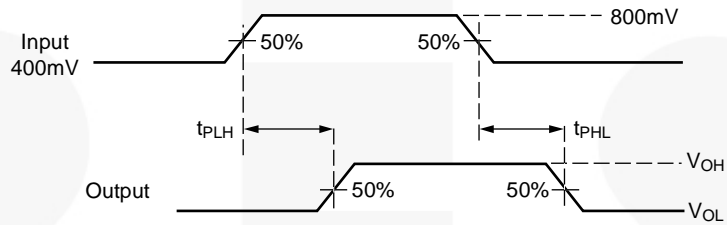


Figure 14. Propagation Delay

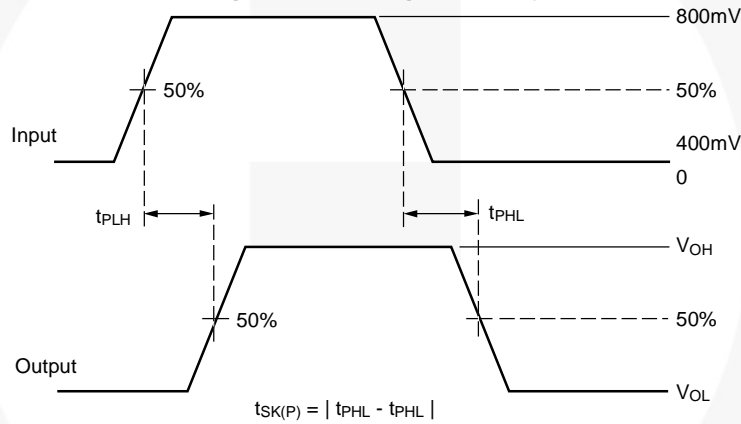


Figure 15. Pulse Skew  $t_{SP(P)}$

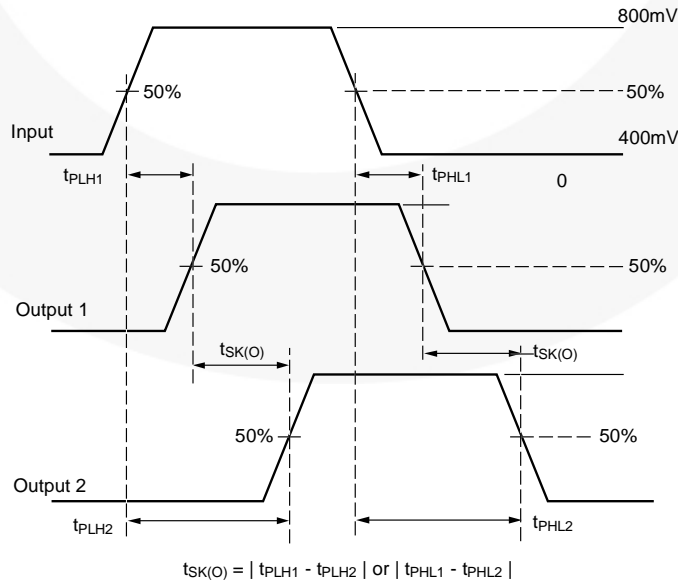
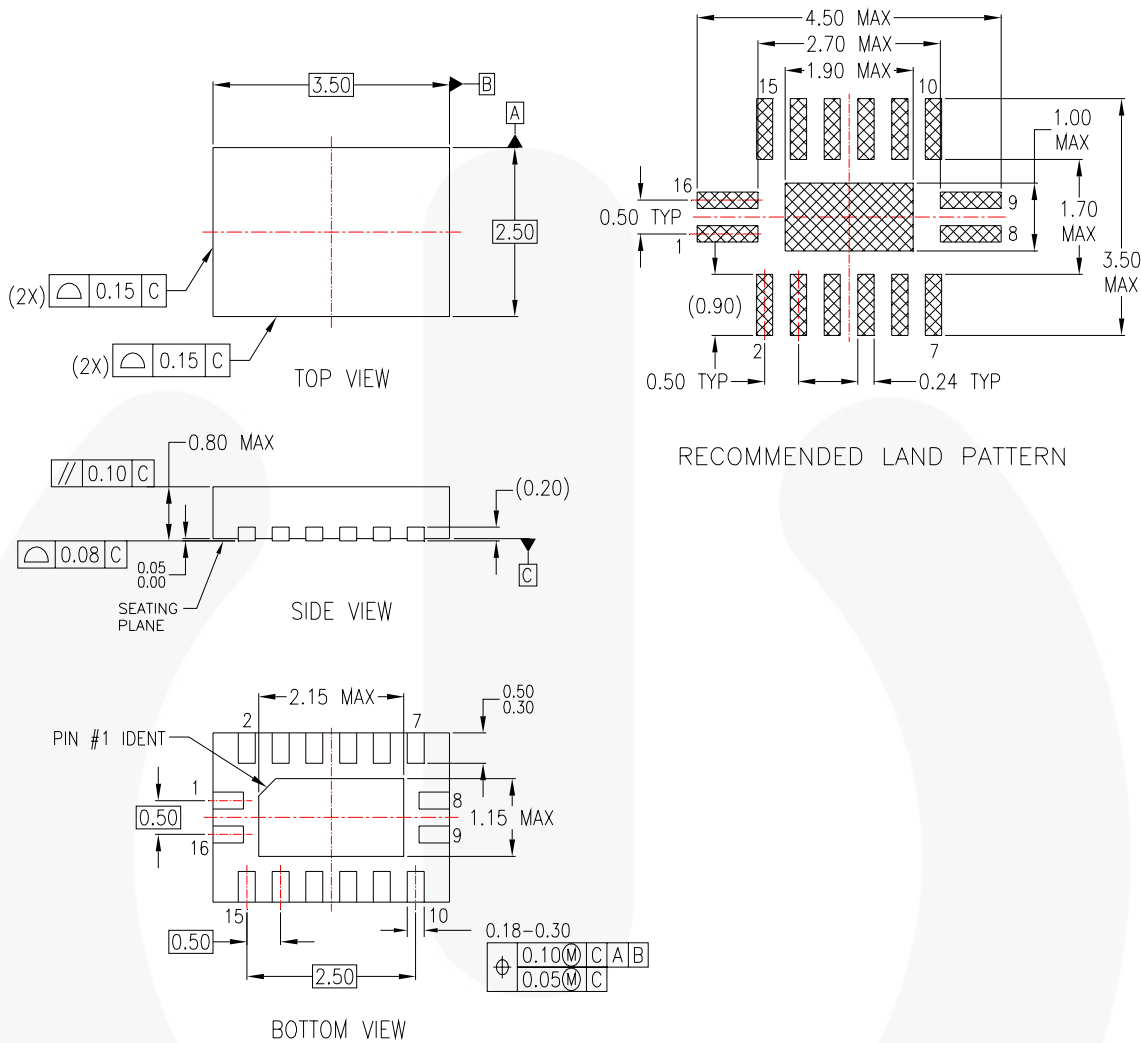


Figure 16. Output Skew  $t_{SK(O)}$

## Physical Dimensions



### NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AB
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP16ErevA

Figure 17. 16-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.5mm

**Note:** [click here for tape and reel specifications, available at:](#)

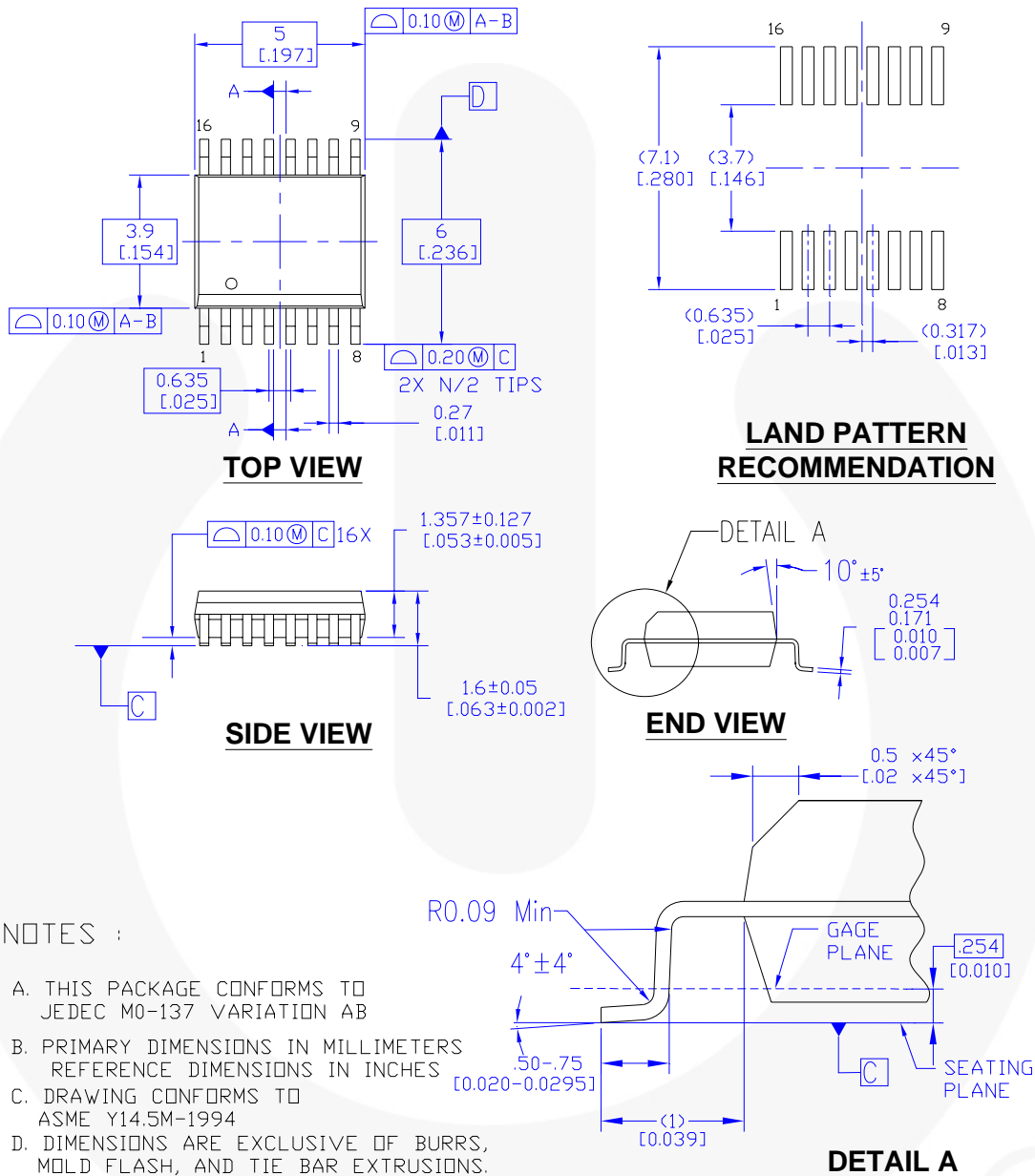
[http://www.fairchildsemi.com/products/analog/pdf/MLP16\\_25x35\\_TNR.pdf](http://www.fairchildsemi.com/products/analog/pdf/MLP16_25x35_TNR.pdf)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

## Physical Dimensions



### NOTES :

- THIS PACKAGE CONFORMS TO JEDEC MO-137 VARIATION AB
- PRIMARY DIMENSIONS IN MILLIMETERS  
REFERENCE DIMENSIONS IN INCHES
- DRAWING CONFORMS TO ASME Y14.5M-1994
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

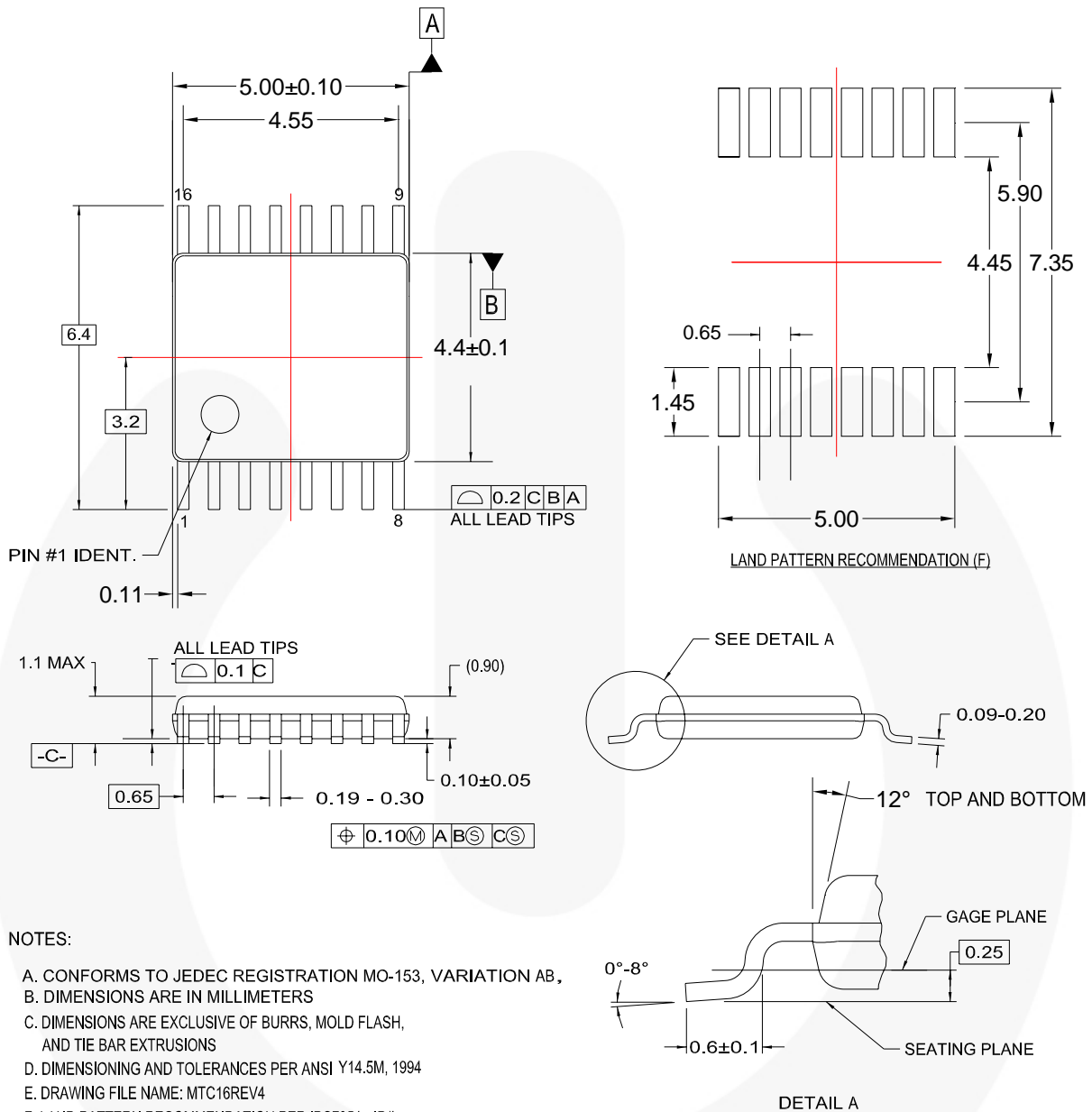
MQA16AREVB

**Figure 18. 16-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150-inch Wide**

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:  
<http://www.fairchildsemi.com/packaging/>

### Physical Dimensions



**NOTES:**

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB,
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1994
- E. DRAWING FILE NAME: MTC16REV4
- F. LAND PATTERN RECOMMENDATION PER IPC7351 - ID# TSOP65P640X110-16N

MTC16rev4

**Figure 19. 16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide**

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:  
<http://www.fairchildsemi.com/packaging/>



**TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

- |   |   |   |   |
|---|---|---|---|
| ACEx <sup>®</sup>   | FPST <sup>™</sup>                             | PDP SPM <sup>™</sup>  | The Power Franchise <sup>®</sup>  |
| Build it Now <sup>™</sup>   | F-PFS <sup>™</sup>                            | Power-SPM <sup>™</sup>  |  |
| CorePLUS <sup>™</sup>   | FRFET <sup>®</sup>                            | PowerTrench <sup>®</sup>  | TinyBoost <sup>™</sup>  |
| CorePOWER <sup>™</sup>  | Global Power Resource <sup>SM</sup>           | Programmable Active Droop <sup>™</sup>  | TinyBuck <sup>™</sup>   |
| CROSSVOLT <sup>™</sup>  | Green FPST <sup>™</sup>                       | QFET <sup>®</sup>   | TinyLogic <sup>®</sup>  |
| CTL <sup>™</sup>  | Green FPST <sup>™</sup> e-Series <sup>™</sup> | QST <sup>™</sup>  | TINYOPTO <sup>™</sup>   |
| Current Transfer Logic <sup>™</sup>   | GTO <sup>™</sup>                              | Quiet Series <sup>™</sup>   | TinyPower <sup>™</sup>  |
| EcoSPARK <sup>®</sup>   | IntelliMAX <sup>™</sup>                       | RapidConfigure <sup>™</sup>   | TinyPWM <sup>™</sup>  |
| EfficientMax <sup>™</sup>   | ISOPLANAR <sup>™</sup>                        | Saving our world, 1mW at a time <sup>™</sup>                                      | TinyWire <sup>™</sup>   |
| EZSWITCH <sup>™</sup> *   | MegaBuck <sup>™</sup>                         | SmartMax <sup>™</sup>   | μSerDes <sup>™</sup>  |
|  | MICROCOUPLER <sup>™</sup>                     | SMART START <sup>™</sup>  |  |
|  | MicroFET <sup>™</sup>                         | SPM <sup>®</sup>  | UHC <sup>®</sup>  |
| Fairchild <sup>®</sup>  | MicroPak <sup>™</sup>                         | STEALTH <sup>™</sup>  | Ultra FRFET <sup>™</sup>  |
| Fairchild Semiconductor <sup>®</sup>  | MillerDrive <sup>™</sup>                      | SuperFET <sup>™</sup>   | UniFET <sup>™</sup>   |
| FACT Quiet Series <sup>™</sup>  | MotionMax <sup>™</sup>                        | SuperSOT <sup>™</sup> -3  | VCX <sup>™</sup>  |
| FACT <sup>®</sup>   | Motion-SPM <sup>™</sup>                       | SuperSOT <sup>™</sup> -6  | VisualMax <sup>™</sup>  |
| FAST <sup>®</sup>   | OPTOLOGIC <sup>®</sup>                        | SuperSOT <sup>™</sup> -8  |   |
| FastvCore <sup>™</sup>  | OPTOPLANAR <sup>®</sup>                       | SupreMOS <sup>™</sup>   |   |
| FlashWriter <sup>®</sup> *  |   | SyncFET <sup>™</sup>  |   |
|   |   |  |   |

\* EZSWITCH<sup>™</sup> and FlashWriter<sup>®</sup> are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

**DISCLAIMER**

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

**LIFE SUPPORT POLICY**

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

**PRODUCT STATUS DEFINITIONS**

**Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	This datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I34

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor:](#)

[FSUSB22MTCX](#) [FSUSB22BQX](#) [FSUSB22QSCX](#)

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9